

(12) PATENT APPLICATION PUBLICATION

(21) Application No.202211016511 A

(19) INDIA

(22) Date of filing of Application :24/03/2022

(43) Publication Date : 02/02/2024

(54) Title of the invention : SOLDERING ASSISTIVE DEVICE FOR ELECTRONIC BOARDS

(51) International classification	:F16M0011180000, H05K0003340000, G06T0007000000, H04N0001000000, H05K0001140000	(71) Name of Applicant : 1)Chandigarh Group of Colleges, Jhanjeri Address of Applicant :State Highway 12A Jhanjeri, Sahibzada, Ajit Singh Nagar, Punjab 140307, India. Punjab India
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(61) Patent of Addition to Application Number	:NA	
Filing Date	:NA	
(62) Divisional to Application Number	:NA	
Filing Date	:NA	

(57) Abstract :

A soldering assistive device for electronic boards, comprising of a housing 1 having a platform 2 for positioning of an electronic board that needs to be soldered, a touch interactive display panel 3 that displays a set of circuits, among which a user selects a desired circuit to work on for practicing soldering, a robotic arm 6 integrated with a motorized C-shaped clamp equipped with a soldering gun 7 that is aligned over board and held manually by user while performing soldering, a projector 4 configured on a ceiling portion inside the housing 1 that projects a virtual image of the selected circuit over the board, a primary artificial intelligence enabled image capturing module 8 for assisting user in properly visualizing the soldering operation, a pneumatically operated telescopic rod 10 integrated with a hydraulically operated claw type arrangement 11 configured with test probes 12 for evaluating quality of soldering.

No. of Pages : 14 No. of Claims : 7